

LOCTITE ECCOBOND 3005

August 2012

PRODUCT DESCRIPTION

LOCTITE ECCOBOND 3005 provides the following product characteristics:

Technology	Silicone	
Appearance	Off-white	
Cure	Heat cure	
Product Benefits	Non-conductive	
	 Low modulus 	
	 Good adhesion 	
	 Ultra-low moisture absorption 	
	 Chemical compatibility with 	
	silicone gels	
Application	Lid attach	
Filler Type	Silica	
Typical Package	Flip Chip BGA	
Application(s)		
Other Application Areas	Thermally enhanced stiffener	

LOCTITE ECCOBOND 3005 adhesive is designed for lid attach in flip chip BGA applications

The combination of product features result in superior flip chip BGA reliability

This material is sensitive to amines, phosphorus, sulfur and tin containing components

This material needs to be isolated from uncured epoxy-based resins as interaction will inhibit curing

TYPICAL PROPERTIES OF UNCURED MATERIAL

Thixotropic Index (0.5/5 rpm)	≥2.5
Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):	
Speed 5 rpm	44,000
Work Life @ 25°C, hours	24
Shelf Life @ -40°C, days	365
Flash Point - See SDS	

TYPICAL CURING PERFORMANCE

Cure Schedule

30 minutes @ 150°C

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and specific application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL Physical Properties

Coefficient of Linear Thermal Expansion, ppm/°C:	
Below Tg	32
Above Tg	136
Glass Transition Temperature (Tg) by TMA, °C	-15
Topoile Medulus DMTA:	

Toriono Modalao, Divili	
@ -65 °C	N/mm ² 7,918
	(psi) (1,148,000
@ 25 °C	N/mm² 358
	(psi) (51,948)
@ 150 °C	N/mm² 52
	(psi) (10,824)

Extractable Ionic Content, @ 100°C:

Chloride (Cl-)	≤10
Sodium (Na+)	≤10
Potassium (K+)	≤10

TYPICAL PERFORMANCE OF CURED MATERIAL

Miscellaneous

Die Shear Strength
120 X 120 mm Si die, Kg,
cured 30 minutes @ 150°C

cured 30 minutes @ 150°C	
Substrate	@25°C
Ni plated Cu substrate	≥ 3.0

Die Shear Strength vs Temperature

3 x 3 x 0.38 mm bare Si die on 0.2 mm thick Ni-plated $\,$ Cu LF,

Kg @25°C @240°C 7 2



GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

THAWING:

- 1. Allow container to reach room temperature before use.
- After removing from the freezer, set the syringes to stand vertically while thawing.
- DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
- DO NOT re-freeze. Once thawed to 25°C, the adhesive should not be re-frozen.

DIRECTIONS FOR USE

1. The recommended needle size for use is 20 guage.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -40 °C. Storage below minus (-)40 °C or greater than minus (-)40 °C can adversely affect product properties.

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Henkel Representative.

Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb/F N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

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